

RJK0354DSP

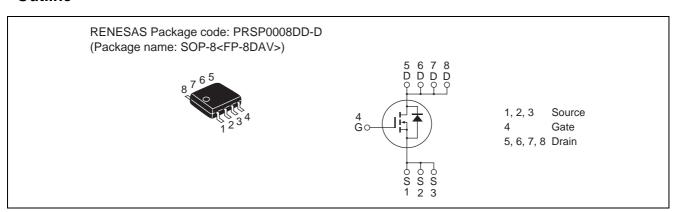
Silicon N Channel Power MOS FET Power Switching

REJ03G1661-0101 Rev.1.01 Apr 24, 2008

Features

- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance $R_{DS(on)} = 5.4 \text{ m}\Omega \text{ typ. (at } V_{GS} = 10 \text{ V)}$
- Pb-free

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

| Item | Symbol | Ratings | Unit |
|--|-----------------------------|-------------|------|
| Drain to source voltage | V _{DSS} | 30 | V |
| Gate to source voltage | V_{GSS} | ±20 | V |
| Drain current | I _D | 16 | А |
| Drain peak current | I _{D(pulse)} Note1 | 128 | А |
| Body-drain diode reverse drain current | I _{DR} | 16 | А |
| Avalanche current | I _{AP} Note 2 | 15 | А |
| Avalanche energy | E _{AR} Note 2 | 22.5 | mJ |
| Channel dissipation | Pch Note3 | 2.0 | W |
| Channel to ambient thermal impedance | θch-a Note3 | 62.5 | °C/W |
| Channel temperature | Tch | 150 | °C |
| Storage temperature | Tstg | -55 to +150 | °C |

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

- 2. Value at Tch = 25°C, Rg \geq 50 Ω
- 3. When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW \leq 10s

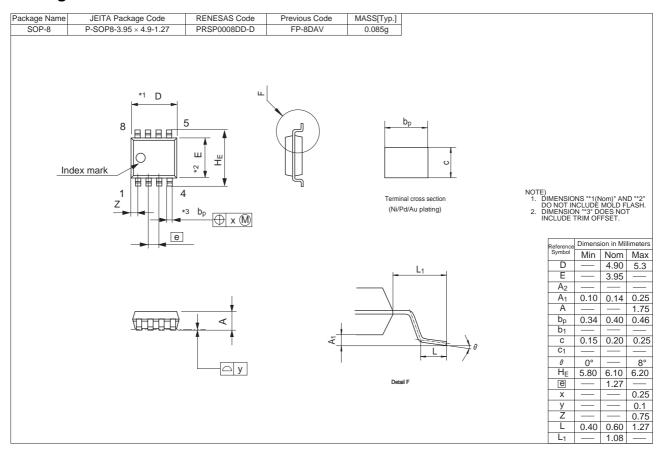
Electrical Characteristics

 $(Ta = 25^{\circ}C)$

| Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|-----------------------------------|----------------------|-----|------|-------|------|--|
| Drain to source breakdown voltage | $V_{(BR)DSS}$ | 30 | _ | _ | V | $I_D = 10 \text{ mA}, V_{GS} = 0$ |
| Gate to source leak current | I _{GSS} | _ | _ | ± 0.1 | μΑ | $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$ |
| Zero gate voltage drain current | I _{DSS} | _ | _ | 1 | μΑ | $V_{DS} = 30 \text{ V}, V_{GS} = 0$ |
| Gate to source cutoff voltage | V _{GS(off)} | 1.2 | _ | 2.5 | V | $V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$ |
| Static drain to source on state | R _{DS(on)} | _ | 5.4 | 7.0 | mΩ | I _D = 8 A, V _{GS} = 10 V Note4 |
| resistance | R _{DS(on)} | _ | 7.5 | 10.5 | mΩ | $I_D = 8 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$ |
| Forward transfer admittance | y _{fs} | _ | 40 | _ | S | I _D = 8 A, V _{DS} = 10 V Note4 |
| Input capacitance | Ciss | _ | 1740 | _ | pF | V _{DS} = 10 V |
| Output capacitance | Coss | _ | 335 | _ | pF | $V_{GS} = 0$ |
| Reverse transfer capacitance | Crss | _ | 110 | _ | pF | f = 1 MHz |
| Gate Resistance | Rg | _ | 4.4 | _ | Ω | |
| Total gate charge | Qg | _ | 12 | _ | nC | V _{DD} = 10 V |
| Gate to source charge | Qgs | _ | 4.3 | _ | nC | $V_{GS} = 4.5 \text{ V}$ |
| Gate to drain charge | Qgd | _ | 2.5 | _ | nC | I _D = 8 A |
| Turn-on delay time | t _{d(on)} | _ | 7.4 | _ | ns | V _{GS} = 10 V, I _D = 8 A |
| Rise time | t _r | _ | 3.6 | _ | ns | V _{DD} ≅ 10 V |
| Turn-off delay time | t _{d(off)} | _ | 56.4 | _ | ns | $R_L = 1.25 \Omega$ |
| Fall time | t _f | _ | 5.5 | _ | ns | $Rg = 4.7 \Omega$ |
| Body-drain diode forward voltage | V_{DF} | _ | 0.81 | 1.06 | V | $I_F = 16 \text{ A}, V_{GS} = 0^{\text{Note4}}$ |
| Body-drain diode reverse recovery | t _{rr} | _ | 20 | _ | ns | $I_F = 16 \text{ A}, V_{GS} = 0$ |
| time | | | | | | $di_F/dt = 100 A/ \mu s$ |

Notes: 4. Pulse test

Package Dimensions



Ordering Information

| Part No. | Quantity | Shipping Container |
|------------------|----------|--------------------|
| RJK0354DSP-00-J0 | 2500 pcs | Taping |

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